## Maria De Souza

## List of Publications by Citations

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76
papers

1,831
h-index

84
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ext. papers

19
h-index

3.1
ext. citations

3.1
ext. citations

4.74
ext. papers

#	Paper	IF	Citations
76	The 2018 GaN power electronics roadmap. <i>Journal Physics D: Applied Physics</i> , <b>2018</b> , 51, 163001	3	527
75	Investigating the stability of zinc oxide thin film transistors. <i>Applied Physics Letters</i> , <b>2006</b> , 89, 263513	3.4	260
74	A low temperature combination method for the production of ZnO nanowires. <i>Nanotechnology</i> , <b>2005</b> , 16, 2188-92	3.4	167
73	Surface intercalation of gold underneath a graphene monolayer on SiC(0001) studied by scanning tunneling microscopy and spectroscopy. <i>Applied Physics Letters</i> , <b>2009</b> , 94, 263115	3.4	97
72	Nanoionics-Based Three-Terminal Synaptic Device Using Zinc Oxide. <i>ACS Applied Materials &amp; Amp; Interfaces</i> , <b>2017</b> , 9, 1609-1618	9.5	91
71	A Comparison of the Performance and Stability of ZnO-TFTs With Silicon Dioxide and Nitride as Gate Insulators. <i>IEEE Transactions on Electron Devices</i> , <b>2008</b> , 55, 1109-1115	2.9	81
70	Communication: electronic band gaps of semiconducting zig-zag carbon nanotubes from many-body perturbation theory calculations. <i>Journal of Chemical Physics</i> , <b>2012</b> , 136, 181101	3.9	35
69	Diffusion-Controlled Faradaic Charge Storage in High-Performance Solid Electrolyte-Gated Zinc Oxide Thin-Film Transistors. <i>ACS Applied Materials &amp; Discourse (Materials &amp; Discours)</i> 10, 9782-9791	9.5	30
68	The Effect of Gate-Bias Stress and Temperature on the Performance of ZnO Thin-Film Transistors.  IEEE Transactions on Device and Materials Reliability, 2008, 8, 277-282	1.6	26
67	A high performance RF LDMOSFET in thin film SOI technology with step drift profile. <i>Solid-State Electronics</i> , <b>2003</b> , 47, 1937-1941	1.7	25
66	Impact of aluminum nitride as an insulator on the performance of zinc oxide thin film transistors. <i>Applied Physics Letters</i> , <b>2008</b> , 92, 093509	3.4	24
65	Electronic properties of extended graphene nanomaterials from GW calculations. <i>Physica Status Solidi (B): Basic Research</i> , <b>2009</b> , 246, 2572-2576	1.3	23
64	Comparative study of drift region designs in RF LDMOSFETs. <i>IEEE Transactions on Electron Devices</i> , <b>2004</b> , 51, 1296-1303	2.9	22
63	Experimental demonstration of an ultra-fast double gate inversion layer emitter transistor (DG-ILET). <i>IEEE Electron Device Letters</i> , <b>2002</b> , 23, 725-727	4.4	22
62	Design for Reliability: The RF Power LDMOSFET. <i>IEEE Transactions on Device and Materials Reliability</i> , <b>2007</b> , 7, 162-174	1.6	21
61	Experimental evidence for exciton scaling effects in self-assembled molecular wires. <i>Physical Review Letters</i> , <b>2004</b> , 93, 257401	7.4	21
60	A novel trench clustered insulated gate bipolar transistor (TCIGBT). <i>IEEE Electron Device Letters</i> , <b>2000</b> , 21, 613-615	4.4	21

## (1999-2010)

59	Superlattice of resonators on monolayer graphene created by intercalated gold nanoclusters. <i>Europhysics Letters</i> , <b>2010</b> , 91, 66004	1.6	20	
58	A novel double RESURF LDMOS for HVICR. Microelectronics Journal, 2004, 35, 305-310	1.8	20	
57	Innovation in power semiconductor industry: past and future. <i>IEEE Transactions on Engineering Management</i> , <b>2005</b> , 52, 429-439	2.6	18	
56	High-Efficiency Modes Contiguous With Class B/J and Continuous Class F \$^{-1}\$ Amplifiers. <i>IEEE Microwave and Wireless Components Letters</i> , <b>2019</b> , 29, 137-139	2.6	17	
55	. IEEE Transactions on Electron Devices, <b>2007</b> , 54, 2991-2997	2.9	16	
54	Transport mechanisms and effective Schottky barrier height of ZnO/a-Si:H and ZnO/Ē-Si:H heterojunction solar cells. <i>Journal of Applied Physics</i> , <b>2013</b> , 114, 184505	2.5	15	
53	Design of Schottky Contacts for Optimum Performance of Thin-Film Silicon Solar Cells. <i>IEEE Journal of Photovoltaics</i> , <b>2015</b> , 5, 22-27	3.7	14	
52	Striped anode engineering: a concept for fast switching power devices. <i>Solid-State Electronics</i> , <b>2002</b> , 46, 903-909	1.7	14	
51	Planar Self-Interstitial in Silicon. <i>Physical Review Letters</i> , <b>1999</b> , 83, 1799-1801	7.4	12	
50	A novel area efficient floating field limiting ring edge termination technique. <i>Solid-State Electronics</i> , <b>2000</b> , 44, 1381-1386	1.7	11	
49	Extraction of Schottky barrier at the F-doped SnO2/TiO2 interface in Dye Sensitized solar cells. <i>Journal of Renewable and Sustainable Energy</i> , <b>2014</b> , 6, 013142	2.5	10	
48	A segmented anode, npn controlled lateral insulated gate bipolar transistor. <i>Solid-State Electronics</i> , <b>2001</b> , 45, 1055-1058	1.7	10	
47	Negative Capacitance beyond Ferroelectric Switches. <i>ACS Applied Materials &amp; Amp; Interfaces</i> , <b>2018</b> , 10, 19812-19819	9.5	10	
46	Evaluation of the Coulomb-limited mobility in high-ldielectric metal oxide semiconductor field effect transistors. <i>Journal of Applied Physics</i> , <b>2010</b> , 107, 063706	2.5	9	
45	A study of the performance of solar cells for indoor autonomous wireless sensors 2016,		8	
44	Numerical Analysis of 3-D Scaling Rules on a 1.2-kV Trench Clustered IGBT. <i>IEEE Transactions on Electron Devices</i> , <b>2018</b> , 65, 1440-1446	2.9	7	
43	. IEEE Transactions on Electron Devices, <b>2010</b> , 57, 1642-1650	2.9	7	
42	A novel gate geometry for the IGBT: the trench planar insulated gate bipolar transistor (TPIGBT). <i>IEEE Electron Device Letters</i> , <b>1999</b> , 20, 580-582	4.4	7	

41	Modelling the threshold voltage of p-channel enhancement-mode GaN heterostructure field-effect transistors. <i>IET Power Electronics</i> , <b>2018</b> , 11, 675-680	2.2	6
40	Role of hybridization on the Schottky barrier height of carbon nanotube field effect transistors. <i>Physical Review B</i> , <b>2009</b> , 79,	3.3	6
39	Comparative Analysis of VDMOS/LDMOS Power Transistors for RF Amplifiers. <i>IEEE Transactions on Microwave Theory and Techniques</i> , <b>2009</b> , 57, 2643-2651	4.1	6
38	Analysis of the breakdown voltage in SOI and SOS technologies. Solid-State Electronics, 2002, 46, 255-2	61. <sub>7</sub>	6
37	MOS control device concepts for AC-AC matrix converter applications: the HCD concept for high-efficiency anode-gated devices. <i>IEEE Transactions on Electron Devices</i> , <b>2005</b> , 52, 2075-2080	2.9	6
36	Impact of channel thickness on the performance of an E-mode p-channel MOSHFET in GaN. <i>Applied Physics Letters</i> , <b>2018</b> , 112, 153503	3.4	5
35	Anomalous n-type electrical behaviour of Pd-contacted CNTFET fabricated on small-diameter nanotube. <i>Nanotechnology</i> , <b>2010</b> , 21, 215202	3.4	5
34	Analytic Large-Signal Modeling of Silicon RF Power MOSFETs. <i>IEEE Transactions on Microwave Theory and Techniques</i> , <b>2007</b> , 55, 829-837	4.1	5
33	A novel metal field plate edge termination for power devices. <i>Microelectronics Journal</i> , <b>2001</b> , 32, 323-3	<b>26</b> .8	5
32	Are carbon nanotubes still a viable option for ITRS 2024? <b>2013</b> ,		4
31	An E-Mode p-Channel GaN MOSHFET for a CMOS Compatible PMIC. <i>IEEE Electron Device Letters</i> , <b>2017</b> , 38, 1449-1452	4.4	4
30	The 6.5 kV clustered insulated gate bipolar transistor in homogeneous base technology. <i>Solid-State Electronics</i> , <b>2001</b> , 45, 71-77	1.7	4
29	A p-Channel GaN Heterostructure Tunnel FET With High ON/OFF Current Ratio. <i>IEEE Transactions on Electron Devices</i> , <b>2019</b> , 66, 2916-2922	2.9	3
29		2.9	3
	on Electron Devices, <b>2019</b> , 66, 2916-2922	2.9	3
28	on Electron Devices, <b>2019</b> , 66, 2916-2922  . IEEE Transactions on Electron Devices, <b>2012</b> , 59, 827-834	2.9	3
28 27	on Electron Devices, 2019, 66, 2916-2922  . IEEE Transactions on Electron Devices, 2012, 59, 827-834  Understanding the role of the insulator in the performance of ZnO TFTs. Thin Solid Films, 2009, 518, 11	2.9	3

23	Radial confinement in lateral power devices. <i>Microelectronics Journal</i> , <b>2001</b> , 32, 481-484	1.8	3
22	A comparison of early stage hot carrier degradation behaviour in 5 and 3 V sub-micron low doped drain metal oxide semiconductor field effect transistors. <i>Microelectronics Reliability</i> , <b>2001</b> , 41, 169-177	1.2	3
21	A local charge control technique to improve the forward bias safe operating area of LIGBT. <i>Solid-State Electronics</i> , <b>2000</b> , 44, 1213-1218	1.7	3
20	1200 V fully implanted JI technology. <i>Electronics Letters</i> , <b>2000</b> , 36, 1587	1.1	3
19	A Monte Carlo study of the kickout mechanism of boron diffusion in silicon. <i>Journal of Applied Physics</i> , <b>1996</b> , 79, 2418-2425	2.5	3
18	Trade-off between the Kirk effect and the breakdown performance in resurfed lateral bipolar transistors for high voltage, high frequency applications. <i>Solid-State Electronics</i> , <b>2000</b> , 44, 1869-1873	1.7	2
17	An analysis of the kickout mechanism in silicon. Solid-State Electronics, 1995, 38, 867-872	1.7	2
16	A methodology to design broadband matching networks for continuum mode PAs <b>2019</b> ,		2
15	Reactive inkjet printing of graphene based flexible circuits and radio frequency antennas. <i>Journal of Materials Chemistry C</i> ,	7.1	2
14	An Integrated On-Chip Flux Concentrator for Galvanic Current Sensing. <i>IEEE Electron Device Letters</i> , <b>2018</b> , 39, 1752-1755	4.4	2
13	Separation of bulk and contact interface degradation in thin film silicon solar cells. <i>Journal of Renewable and Sustainable Energy</i> , <b>2015</b> , 7, 063115	2.5	1
12	Designing high power RF amplifiers: An analytic approach <b>2014</b> ,		1
11	New analytical expressions for the design of linear power amplifier using GaN HEMTs 2009,		1
10	Influence of mobility model on extraction of stress dependent sourcedrain series resistance. <i>Microelectronics Reliability</i> , <b>2004</b> , 44, 25-32	1.2	1
9	Designing a Broadband Amplifier Without Load <b>P</b> ull. <i>IEEE Microwave and Wireless Components Letters</i> , <b>2021</b> , 31, 593-596	2.6	1
8	Development of GaN Transducer and On-Chip Concentrator for Galvanic Current Sensing. <i>IEEE Transactions on Electron Devices</i> , <b>2019</b> , 66, 4367-4372	2.9	1
7	Hierarchically Interlaced 2D Copper Iodide/MXene Composite for High Thermoelectric Performance. <i>Physica Status Solidi - Rapid Research Letters</i> ,2100419	2.5	1
6	Investigation of the Effect of Weak Non-Linearities on P1dB and Efficiency of Class B/J/J* Amplifiers. <i>IEEE Transactions on Circuits and Systems II: Express Briefs</i> , <b>2018</b> , 65, 1159-1163	3.5	O

5	Off-State Operation of a Three Terminal Ionic FET for Logic-in-Memory. <i>IEEE Journal of the Electron Devices Society</i> , <b>2019</b> , 7, 1232-1238	2.3	О
4	3D Microstructured Frequency Selective Surface Based on Carbonized Polyimide Films for Terahertz Applications. <i>Advanced Optical Materials</i> ,2102178	8.1	O
3	Analysis of \${rm P}_{b}\$ Centers in Ultrathin Hafnium Silicate Gate Stacks. <i>IEEE Transactions on Electron Devices</i> , <b>2007</b> , 54, 2551-2555	2.9	
2	Impact of the size 4 cluster on low temperature indium diffusion in silicon. <i>Journal of Physics Condensed Matter</i> , <b>2005</b> , 17, S2165-S2170	1.8	
1	Necessary conditions for steep switching in a constant Resistor-Capacitor RCFET. <i>MRS Advances</i> , <b>2021</b> , 6, 540-545	0.7	